

G55 xPro - Pins (I2S breakout)

Friday, October 05, 2018 3:15 PM

PIN MANAGER



G55 xPro - Pins (I2S) - Spreadsheet

NAME	PORT	PIN	EXT-PIN	Notes
	VDDIO	1		
	NRST	2		
	PB12	3		
I2SMCK0	PA04	4	I2C Conn-6(TWCK0)	I2SC0 MCLK, I2C0 CK
I2SDO0	PA03	5	I2C Conn-7(TWD0)	I2SC0 DO, I2C0 D
I2SCK0	PA00	6		I2SC0 BCLK
I2SW50	PA01	7	EXT3-7(TIOB0-PWM+), I2C Conn-2(NCHG, TIOB0)	I2SC0 LRCK
	PA05	8		
	VDDCORE	9		VBUS_DET (USB)
	TEST	10		USB_VBUS_SENSE: GPIO IN PULL-DWN
	PA07	11		
	PA08	12		
	GND	13		
	PB15	14	EXT3-6(GPIO)	
	PB14	15	EXT4-9	
	PA31	16		
LED	PA06	17		LED_AL - Out - Low
	PA16	18		
	PA31	19	EXT4-5	
	PA29	20		
	PA28	21		
	PA15	22	EXT3-(GPIO,WKUP13)	
I2SDO1	PA23	23	EXT1-7(TIOA1)	I2SC1 DO
UHP_DP, I2SDI1	PA22	24		Target USB, I2SC1 DI
UHP_DM	PA21	25		Target USB
	VDDUSB	26		
	VDDIO	27		
	ADVREF	28		
	GND	29		
	VDDOUT	30		
	VDDIO	31		
	VDDIO	32		
	PA17	33	EXT1-3(AD0)	
PCK2	PA18	34	EXT1-4(AD01)	I2SC0 MCLK
I2SCK1	PA19	35	EXT3-3(AD2)	I2SC1 BCLK
I2SW51	PA20	36	EXT3-4(AD3)	I2SC1 LRCK
	PB00	37		
	PB01	38		
	PB02	39		
	PB03	40	EXT3-9(WKUP13, IRQ/GPIO)	
	PA14	41		
	PA13	42		
	PA12	43		
	PA11	44		
	VDDCORE	45		
	PB10	46	EXT1,EXT4-11 (TWD4)	EDBG
	PB11	47	EXT1,EXT4-12(TWCK4)	EDBG
	PA10	48		
	PA09	49		
	PB05	50		
	PA27	51		
I2SMCK1	PA26	52	EXT1-(GPIO UART0 RTS)	I2SC1 MCLK
	GND	53		
	PB06	54		
	PB07	55		
	PA25	56		
	PB13	57	EXT3-9(GPIO, PWM-)	
	PA24	58		
	PB08	59	EXT3- 11(TWD6)	TW6_SDA (I2C6_DA)
	PB09	60	EXT3-12(TWCK6)	TW6_CK (I2C6_CK)

	PA24	58	EXT3-5(TWCK6, PWM+)			
	PB08	59	EXT3- 11(TWD6)	TW6_SDA (I2C6_DA)		
	PB09	60	EXT3-12(TWCK6)	TW6_CK (I2C6_CK)		
SWITCH	PA02	61		SWITCH_AL - In - Low		
USB_VBUS_SENSE	PB04	62		GPIO - In - PullDown		
	JTAGSEL	63				
	PB09	64		VBUS_DET (USB)		

X32 AK4954 SIGNALS - I2SC0/I2C6

SIGNAL	Connector/Port	G55 Signal	G55 Port(Pin)	EXT - Pin	CONFLICTS
GND	J1-1	GND	-	EXT3-1	-
GND	J1-2	GND	-	EXT3-2	-
	J1-3				
	J1-4				
	J1-5				
	J1-6				
I2C SCL1	J1-7	TWCK6	PB09(60)	EXT3-12	XIN (NOTE 2)
STBY/RESET	J1-8	GPIO	PA26()	EXT1-5	-
I2C SDA1	J1-9	TWD6	PB08(59)	EXT3-11	XOUT (NOTE 2)
I2S LRCL	J1-10	I2SWS	PA01(7)	I2CC-2	HOST_I2C (TIOB0-NCHG) (NOTE 1)
I2S SDI	J1-11	I2SDI0	PA02(61)	Solder to R304	SWITCH (NOTE 3)
I2S BCLK	J1-12	I2SCK1	PA00	EXT3-7	PWM+ (unused)
I2S SDO	J1-13	I2SDO	PA03(5)	I2CC-7	HOST_I2C (I2C_SDA) (NOTE 1)
I2S MCLK	J1-14	I2SMCK0	PA04(4)	I2CC-6	HOST_I2C (I2C_SCL) (NOTE 1)
	J1-15				
	J1-16				
+9V	J1-17	-	-	-	-
+3.3V	J1-18		VCC...P3V3	EXT1-20	-
+9V	J1-19	-	-	-	-
+5V_PD	J1-20	-	-	-	-

TEST SIGNALS (OUT)

J506-1 - TEST1 - PA02 (93)

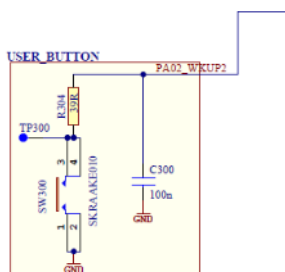
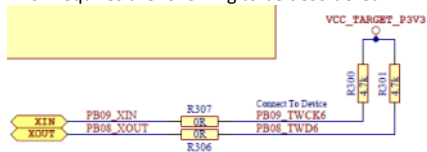
TEST2 - PC19 (117)

Signal	Connector/Pin	E70 Port	E70 Pin
TEST1			
TEST2			
TEST3			
TEST4			
TEST5			

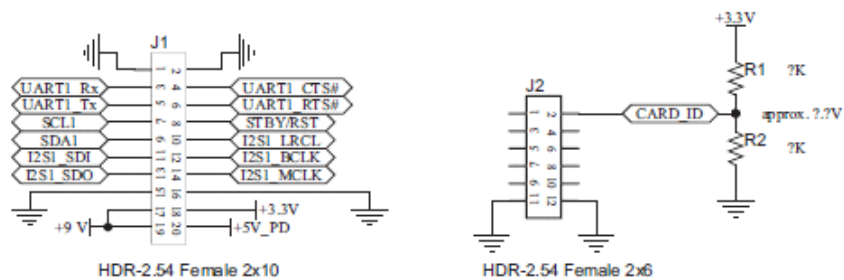
Clock Manager

NOTE(s):

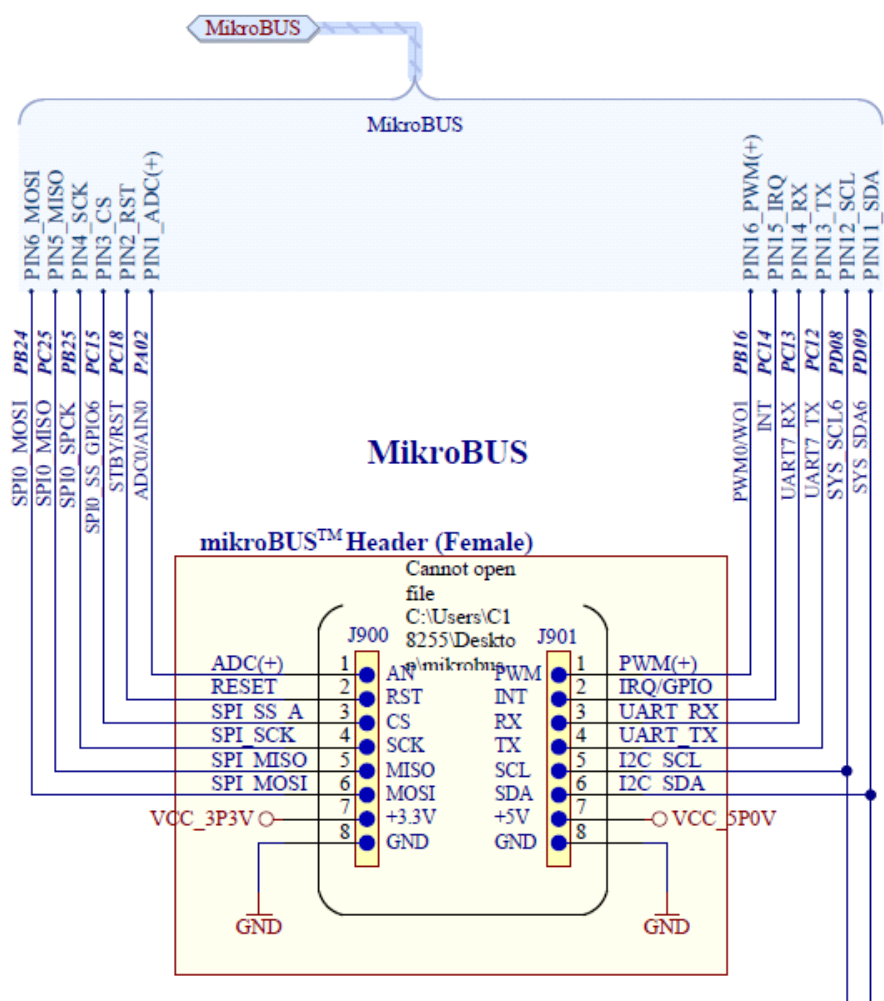
- I2CC is the connector for the high speed HOST_I2C, which is unused.
- PA02 requires the following to be desoldered



- The Switch is required to mute and control volume.



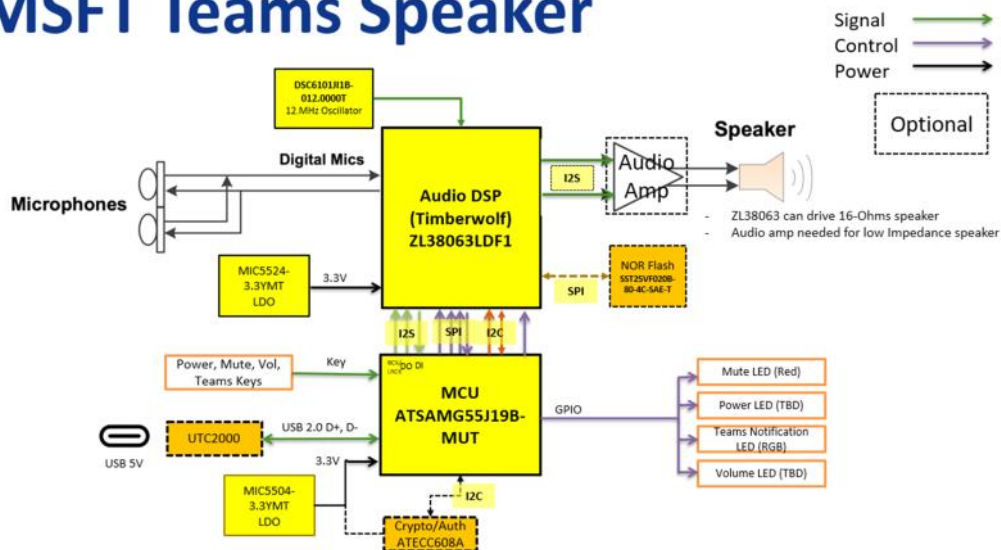
MB CONNECTORS



Friday, July 31, 2020 11:51 AM

[illegible]

MSFT Teams Speaker



USB Audio SSOs - Requirements

Friday, July 31, 2020 11:52 AM



USB Audio(H3) SSOs-4

USB Audio										
Region	City	Customer	Application	First CPN	Alternative CPN	EAU (K/W)	Funnel Stage	Status	DFAE	AE
S.China	Shenzhen	A&D (Tymphony)	conference speaker for MS-Teams	SAMG55	SAMD21	80	3 - system definition	need USB Audio and HID		Simon Huang/Diffin
TW	Taipei	Microsoft/Foxlin	teams conference speakers	SAMG55/D51		300	3 - system definition	USB audio lib and bootloader		
S.China	Shenzhen	A&D (Philips)	Conference Call Speaker	SAMG55	SAMD21	20	3 - system definition	Need USB-Audio lib.		Simon Huang/Diffin
S.China	Shenzhen	Grandsun	conference speaker for MS-Teams	SAMD51/E5x	SAMG55	100	3 - system definition	need USB Audio and HID		Simon Huang/Diffin
Taiwan	Taipei	Jazz Hipster	Conference Call System	PIC32MX230F128	SAM device could be accepted	20	1 - define needs	Need H3 USB Audio, I2S library		Burn Keiffer
Taiwan	Taipei	Meiloon	BT Speaker System	PIC32MX2, PIC32MX4		50	3 - system definition	Need H3 USB Audio to promote new platform such as with BT, Timberwolf.	WFE Spring	
Japan	Tokyo	Ricoh	Conference Call System	ZL38090/SAMG55		30	3 - system definition	A proposal with SAMG55+ZL38063 is under discussing.		
S.China	Shenzhen	Tenveo	Conference Call System	ZL38090/SAMG55		60	1 - define needs	We lost it due to two chips solution is not cost effective. We need ZL38090 for USB audio I/F and ZL38063 for voice processing. Competitor use one chip for USB and voice processor. And it needs an additional MCU for UI control.		Diffin

Name	Disty name	Role	Region	Covered are	What he/she good at?	Rate	recommended tech direction/trainings
Hans Yao	Infortech	FAE	E. China	E.China			MPU 板
JW Chen	Burnon	FAE	E. China	E.China	MPU Linux		MPU 板
Eddie peng	Weikeng	FAE	E. China	E.China			MCUboard
Woolf Zhou	Promaster	FAE	N. China	N. China	MCU32 (PIC32+MCT32)		MCUboard
Vivian Xiao	Promaster	FAE	S. China	ShenZhen			MCUboard
Xueliang Wu	CEAC	FAE	S. China	S.China	MPU + MCU32	6	MCUboard, MPU, Linux, Graphics, driver
Perry Peng	CECP	FAE	W. China	WH, ZZ	MPU + MCU32	7	MCUboard
Oliver Lin	WFE	DFAE	Taiwan	Taiwan, Sou	PIC32		MPU 板